

Towards a chip architecture for acceleration of Deep Neural Networks using Analog Memory

Stefano Ambrogio

Prithish Narayanan

Hsinyu Tsai

Charles Mackin

An Chen

Robert M. Shelby

Geoffrey W. Burr

IBM Research – Almaden

Outline

- Introduction
- Analog memory for training Neural Networks
- Software-equivalent accuracy with novel unit cell
- Circuit design considerations
- Conclusion

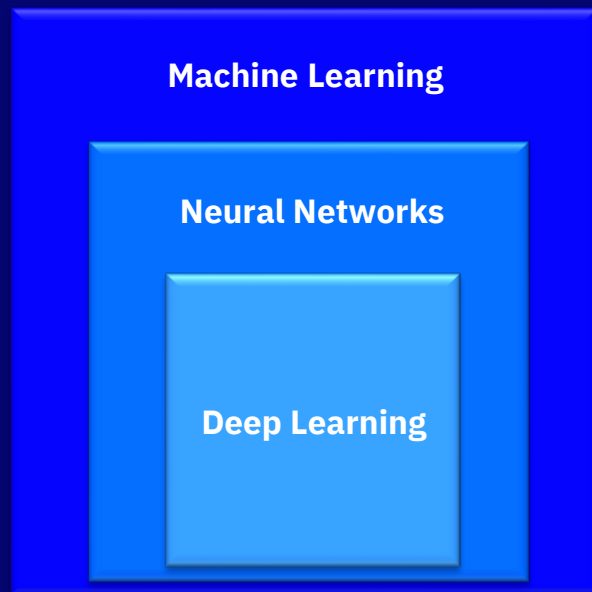
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What is AI?

Artificial Intelligence



Brain Inspired Algorithms

2012: AI foundations

The Deep Learning Explosion

YouTube

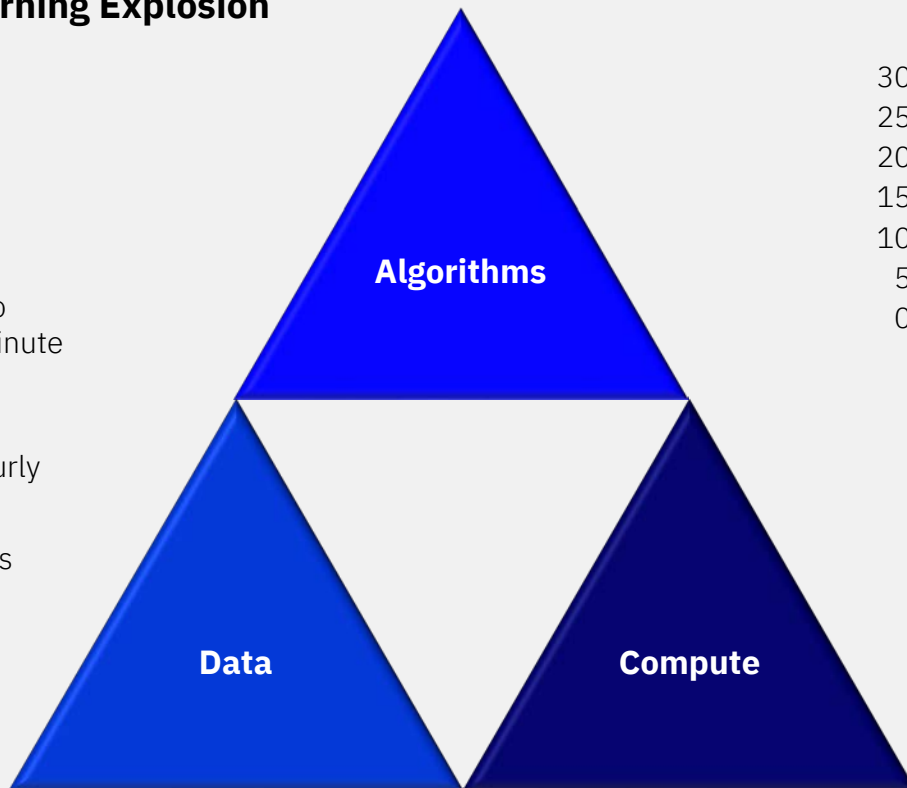
400 hours of video
uploaded every minute

Walmart

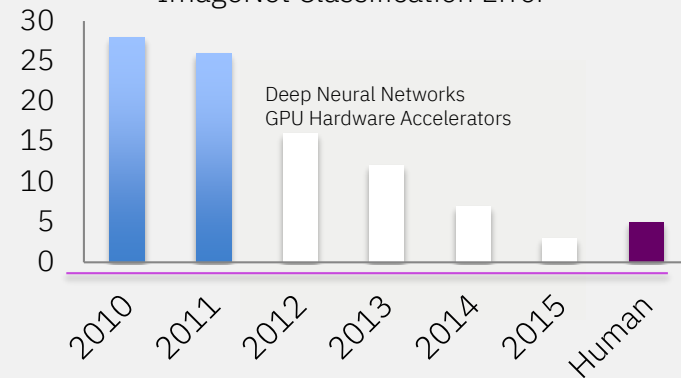
2.5 petabytes of
customer data hourly

Facebook

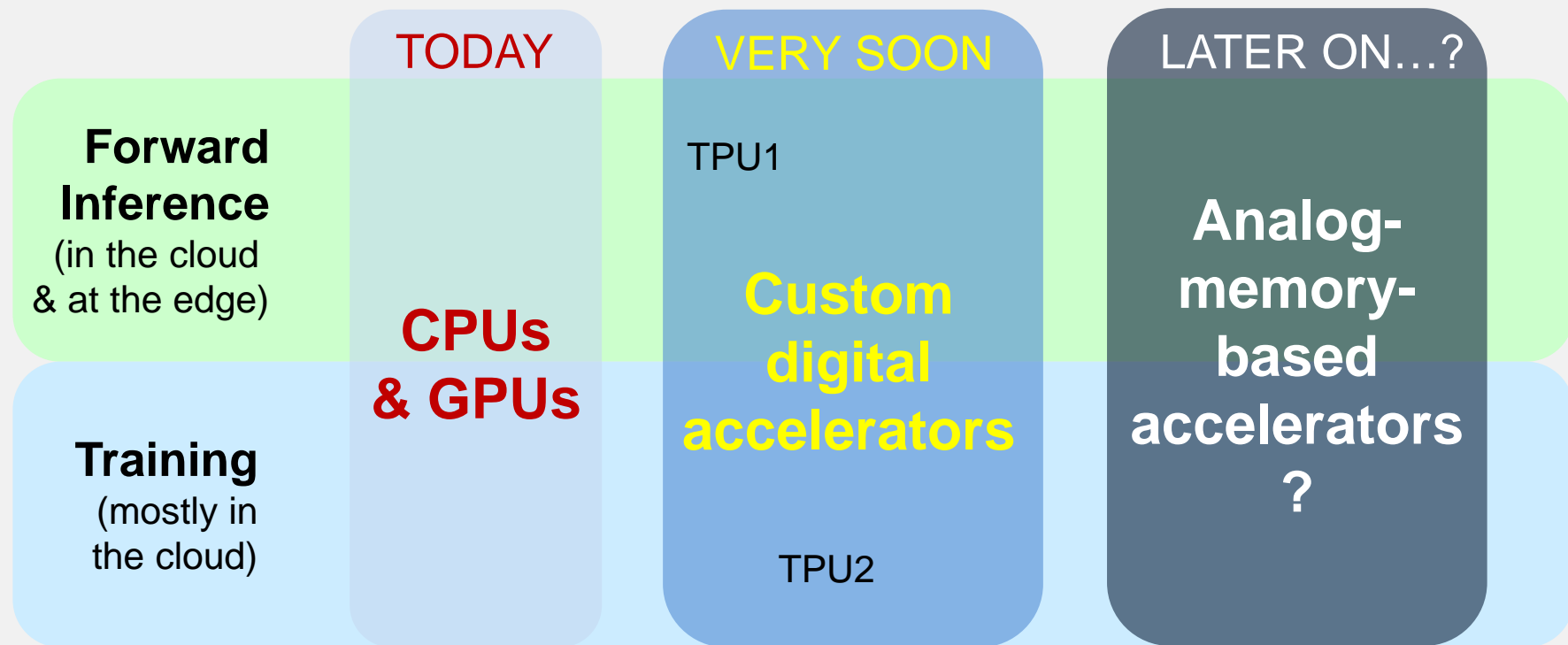
350 million images
uploaded daily



ImageNet Classification Error



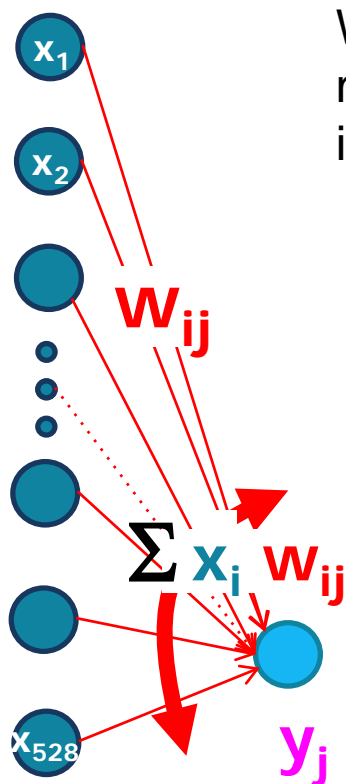
AI hardware, present & near-future: high-level view



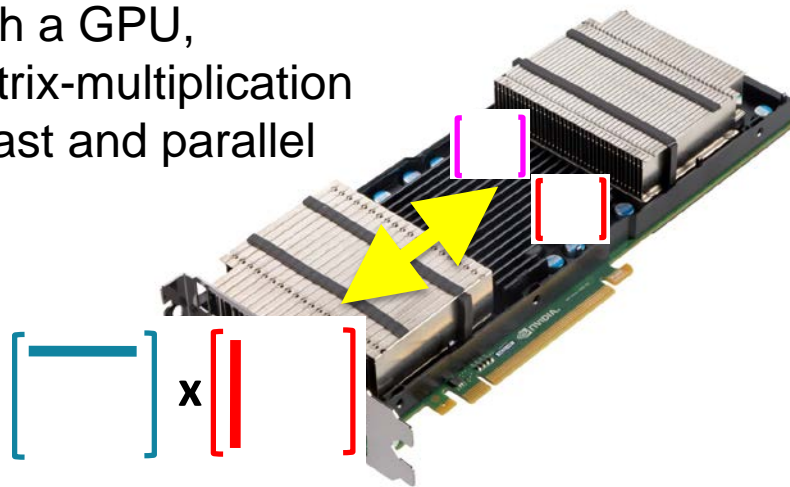
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Computation needed: “Multiply-accumulate”

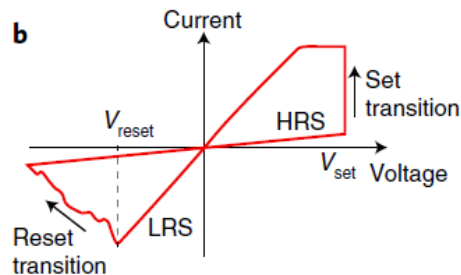
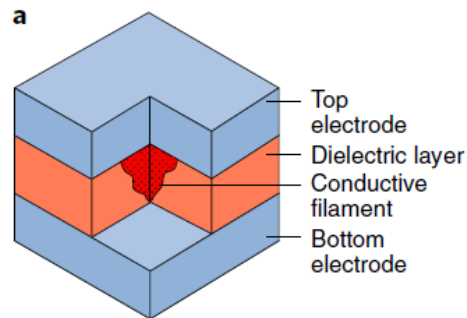


With a GPU,
matrix-multiplication
is fast and parallel

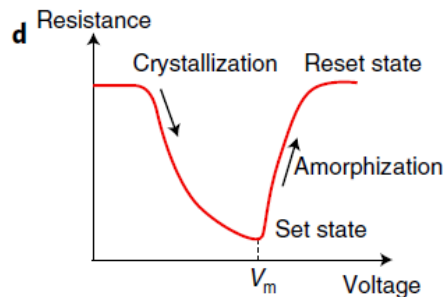
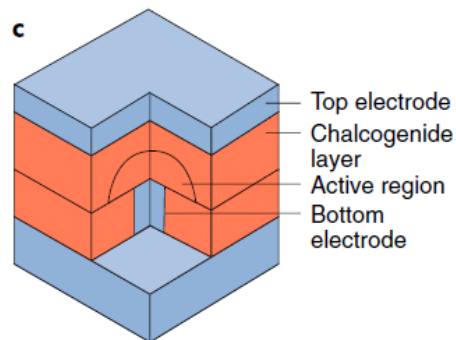


but x and w values must arrive from DRAM
and new y values sent back to DRAM

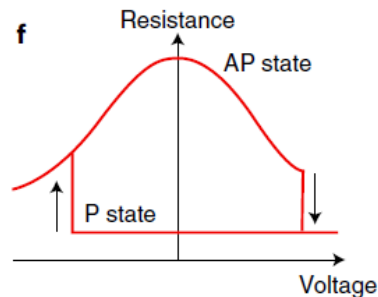
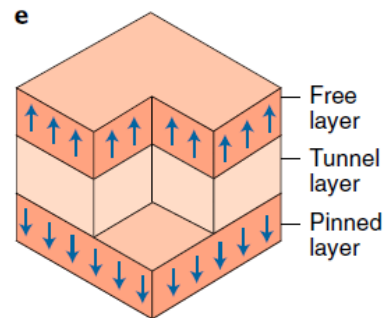
Emerging devices for memory and computing



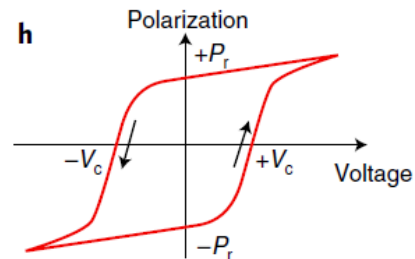
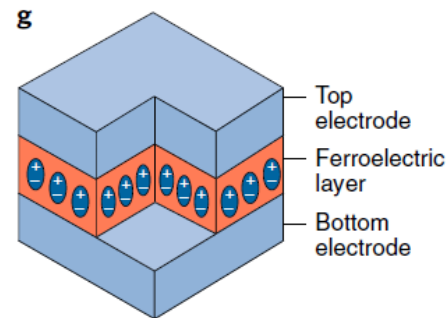
Resistive Memory (RRAM)



Phase-Change Memory (PCM)



Magnetic Memory (MRAM)



Ferro-Electric Memory (FeRAM)

- Information encoded in the device conductance

D. Ielmini, H.-S. P. Wong, Nature Electronics (2018)

NVM (Non-Volatile Memory): usually for storing digital data (0s and 1s)

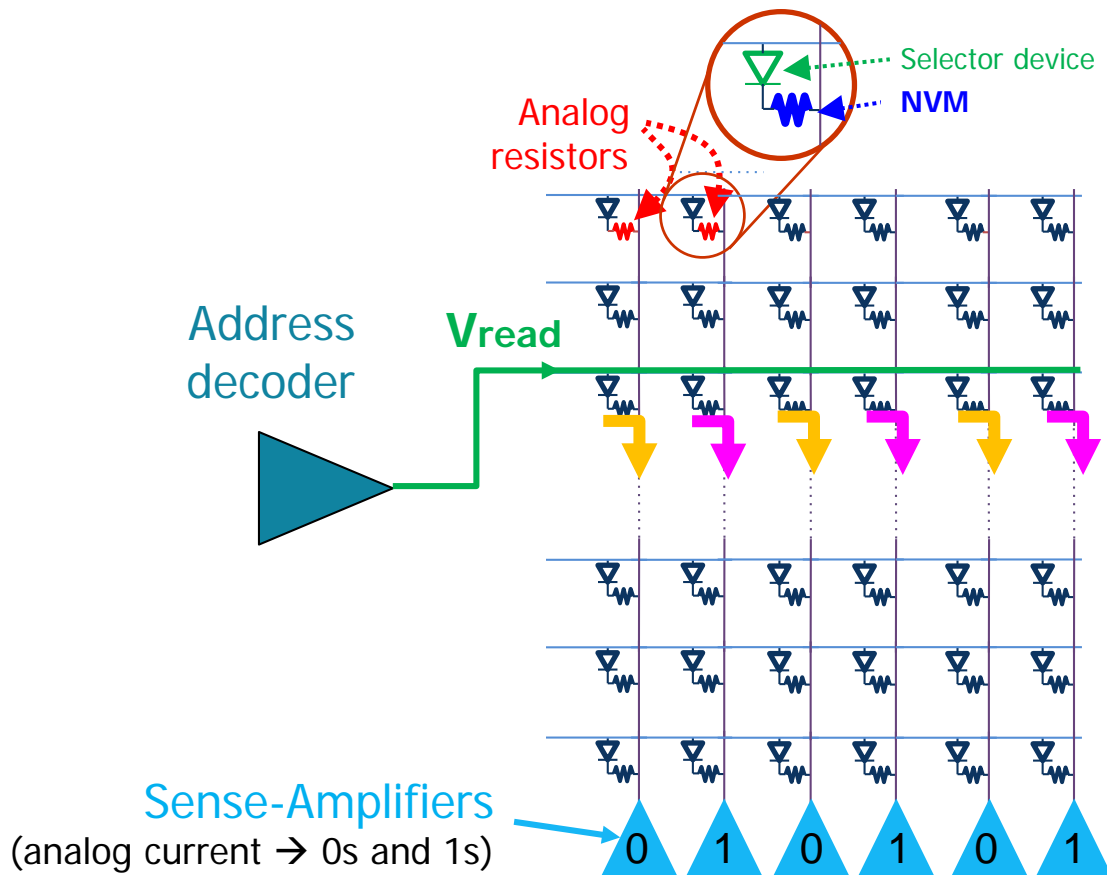
NVM technologies include:

MRAM (Magnetic RAM)

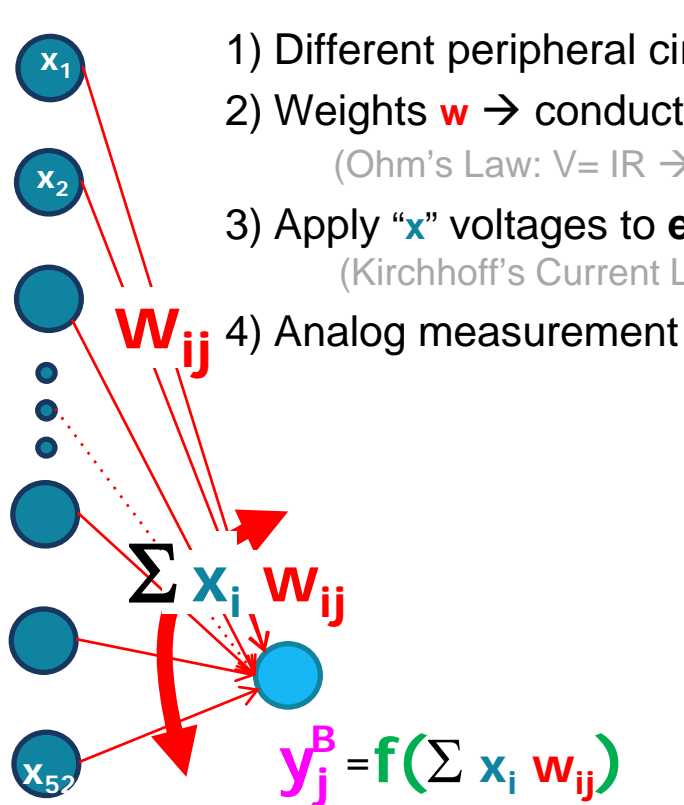
PCM (Phase-Change Memory)

RRAM (Resistance RAM)

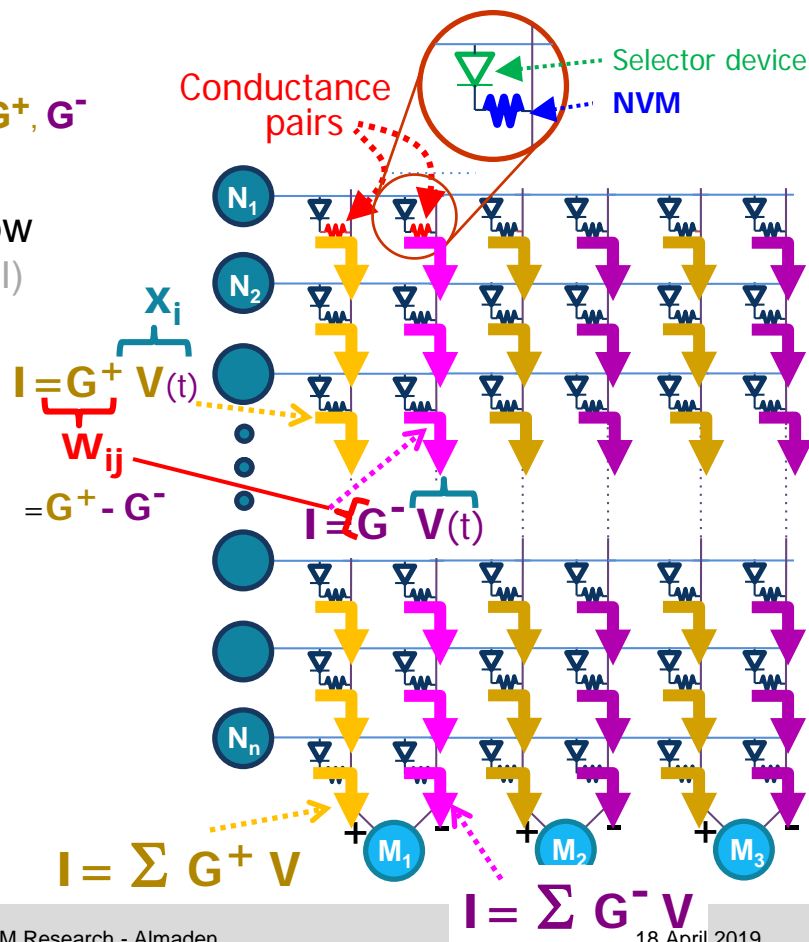
Like conventional memory (SRAM/DRAM/Flash), an NVM is addressed one row at a time, to retrieve previously-stored digital data.



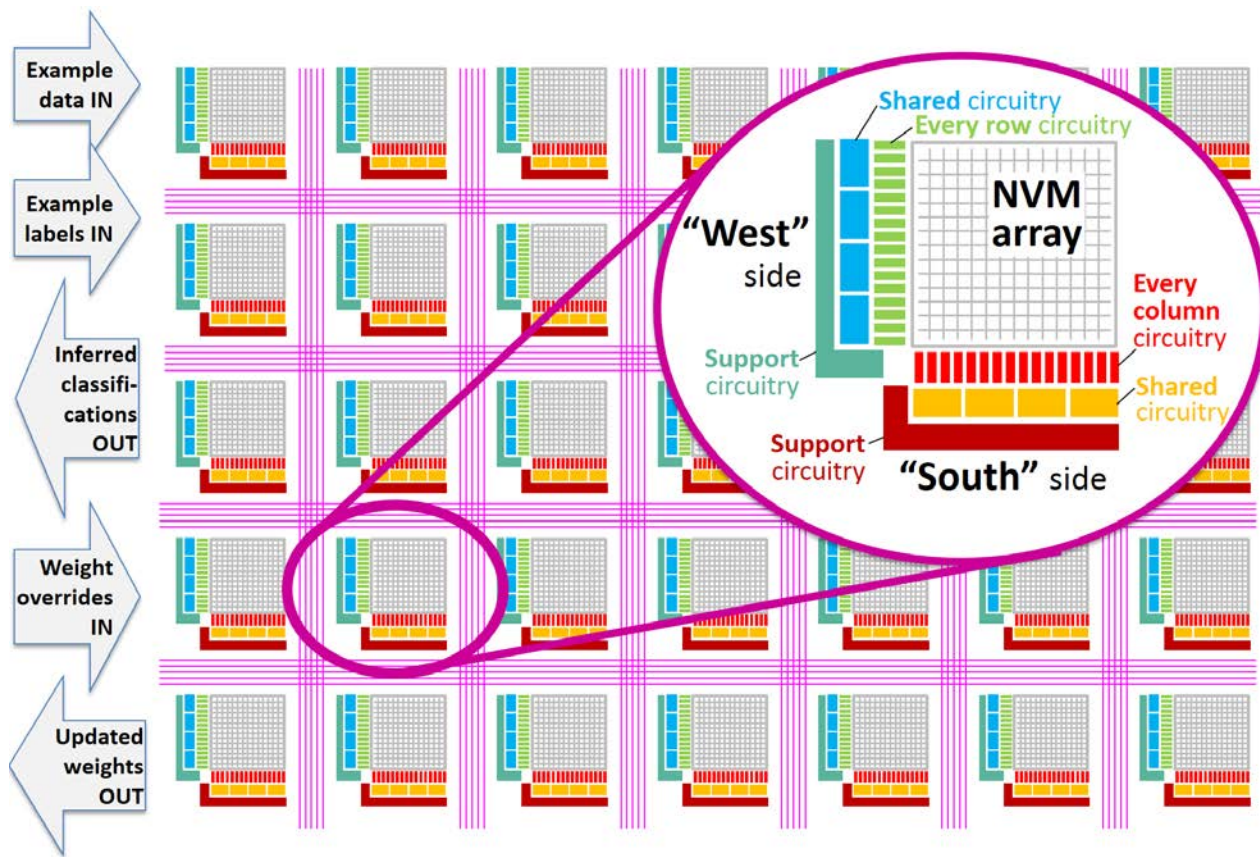
Multiply-accumulate with NVM: computed at the data, by physics



- 1) Different peripheral circuitry
- 2) Weights $w \rightarrow$ conductances G^+, G^-
(Ohm's Law: $V = IR \rightarrow I = GV$)
- 3) Apply " x " voltages to **every** row
(Kirchhoff's Current Law $\rightarrow \Sigma I$)
- 4) Analog measurement



Vision: NVM-based Deep Learning Chip



- Support multiple deep learning algorithms
- Reconfigurable routing: Map different neural net topologies to the same chip
- Weight override mechanism for distributed learning

Maximizing the future business case (vs. a GPU)

Low Power

(inherent in the physics, but possible to lose in the engineering...)

Of zero interest

Still of interest for power-constrained situations: learning-in-cars, etc.

Sweet spot: rather than buy GPUs, people buy this chip instead for training of Deep-NN's

Of zero interest

Accuracy

(essential that final Deep-NN performance be indistinguishable from GPUs – hardest technical challenge)

Of zero interest

Still of interest for some situations: learning-in-server-room

Of zero interest

(circuitry must be massively parallel)

Faster

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Our journey towards high DNN accuracy

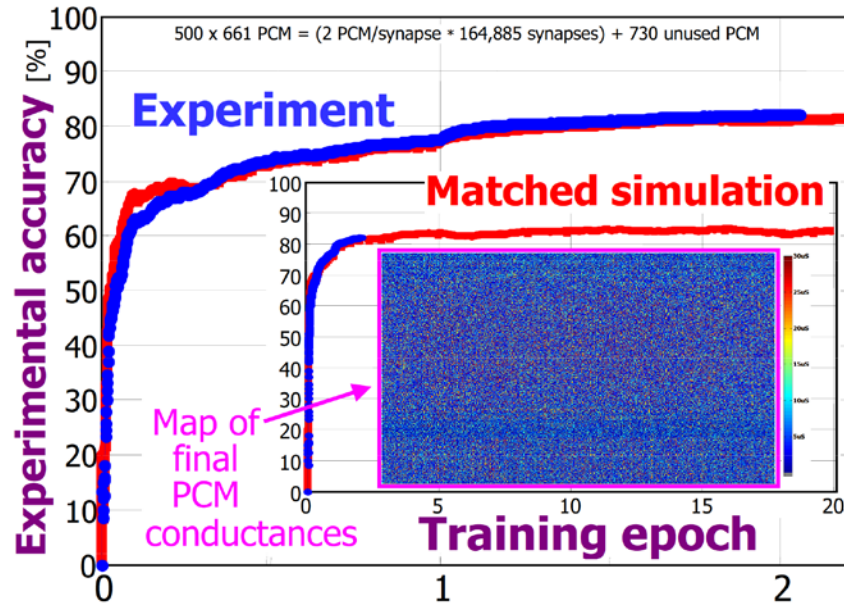
Where we were in 2014

- Experiments on MNIST Dataset
- **82% accuracy** w/ 5,000 examples,
- Too slow for 60,000 examples

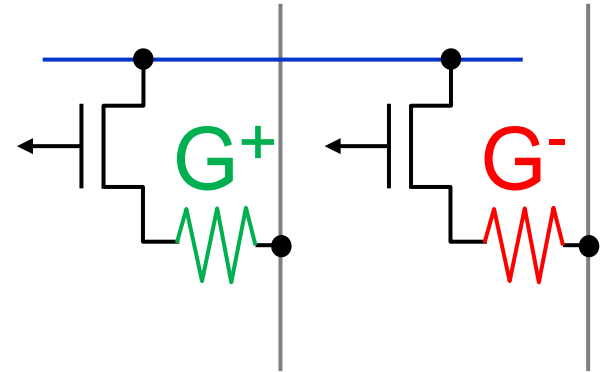
“What a GPU would get” with this network...

97-98% TEST accuracy w/ 60,000 examples

94% TEST accuracy w/ 5,000 examples



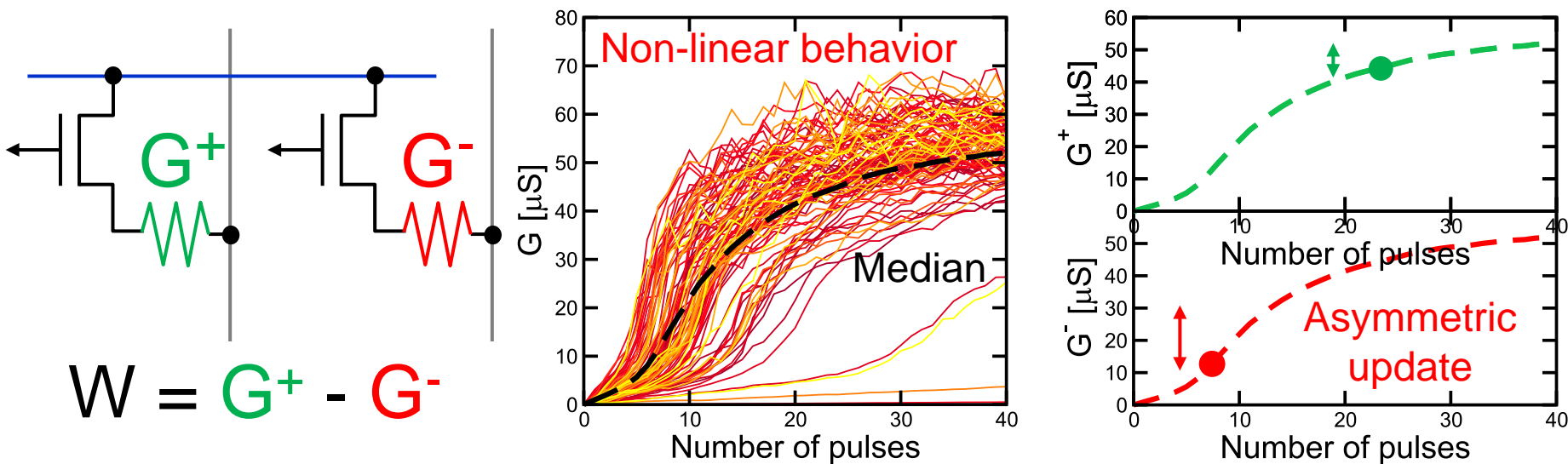
} Non-idealities in Real PCM Devices



$$W = G^+ - G^-$$

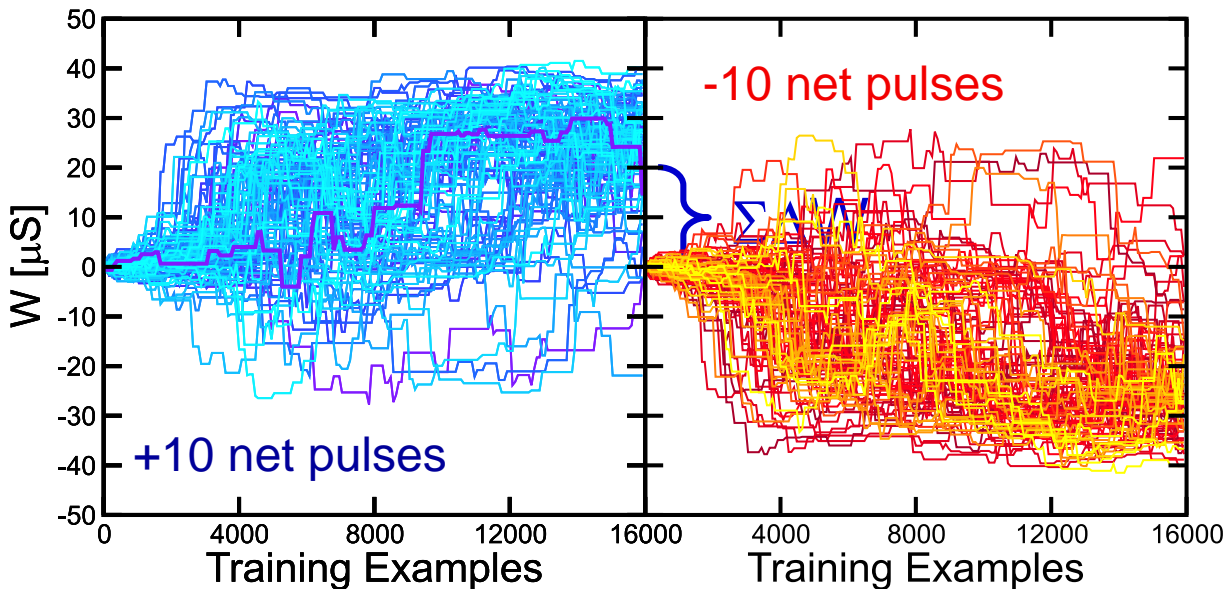
G. W. Burr, R. M. Shelby, et al., *IEDM Technical Digest*, 29.5, (2014).

Study: 2-PCM: Asymmetric Conductance Response

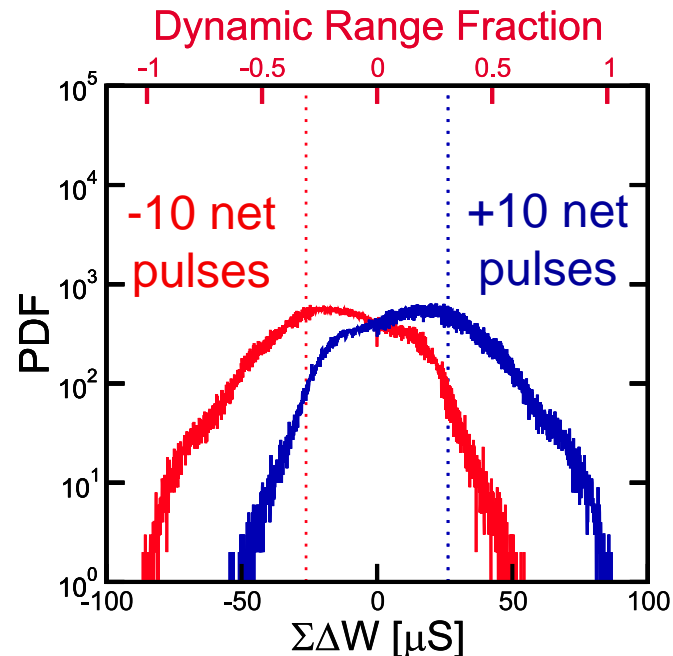


- 2-PCM unit cell is **non-linear** and **asymmetric**
- Symmetry is crucial to balance UP and DOWN steps and accurately implement open-loop weight update
- Strong impact on Neural Network training accuracy

2-PCM scheme: dependence on applied pulses



- $\Sigma\Delta W$ distributions are overlapped, preventing a clear distinction of increase and decrease weight requests
- MNIST accuracy is lower than accuracy achieved with TensorFlow **on a same size** network



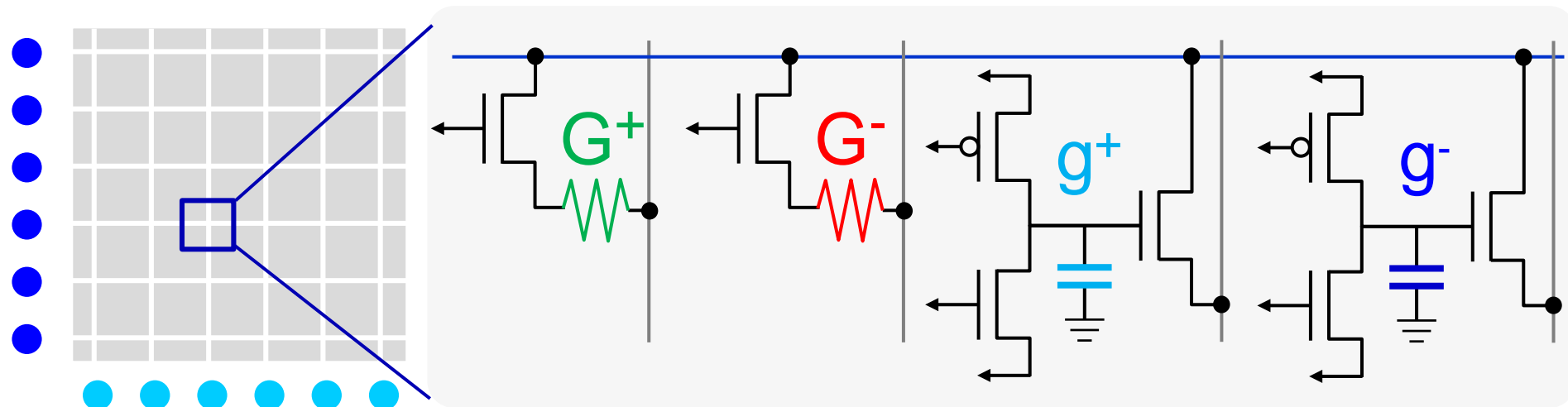
MNIST Accuracy
TensorFlow: 97.94%
2-PCM: 93.77%

Novel 2T2R + 3T1C unit cell

Most Significant Pair
(MSP)

Least Significant Pair
(LSP)

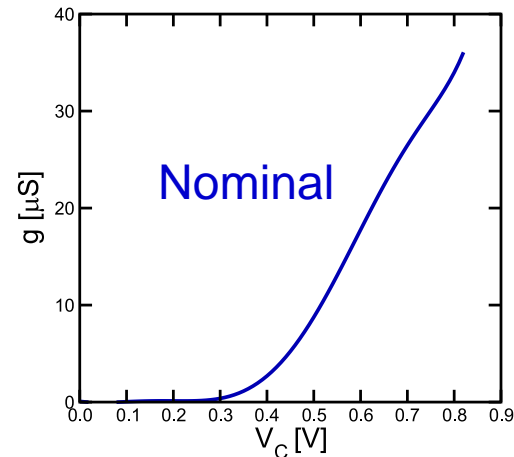
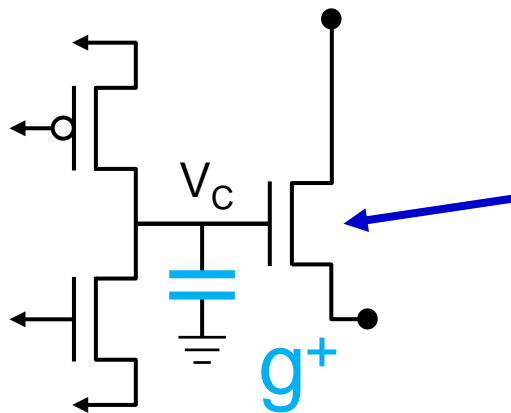
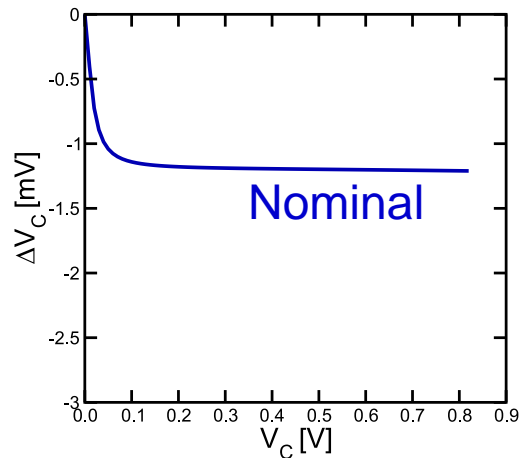
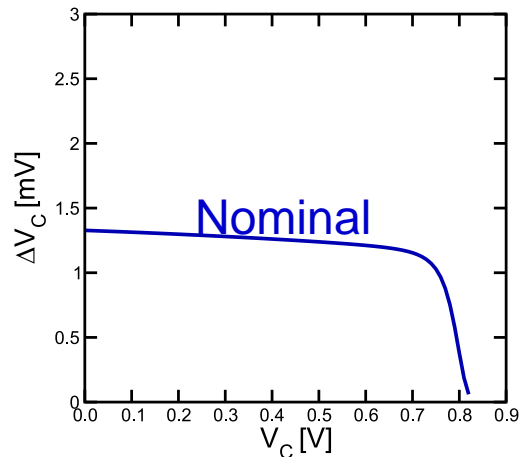
$$W = F \times (G^+ - G^-) + g^+ - g^-$$



- **Symmetry** → Weight update performed on g^+ only
– g^- shared among many columns (e.g. 128 columns)
- **Dynamic Range** → Gain factor F (e.g. $F = 3$)
- **Non-Volatility** → Weight transferred to PCMs infrequently (every 1000s of images)

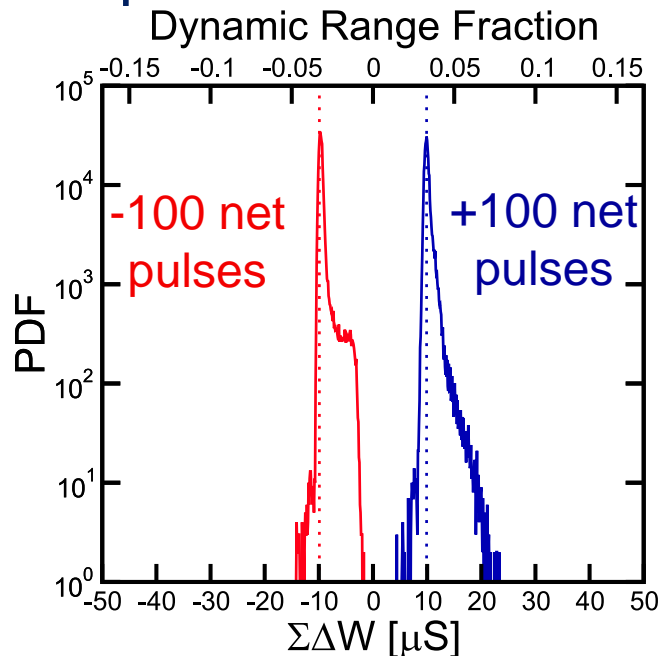
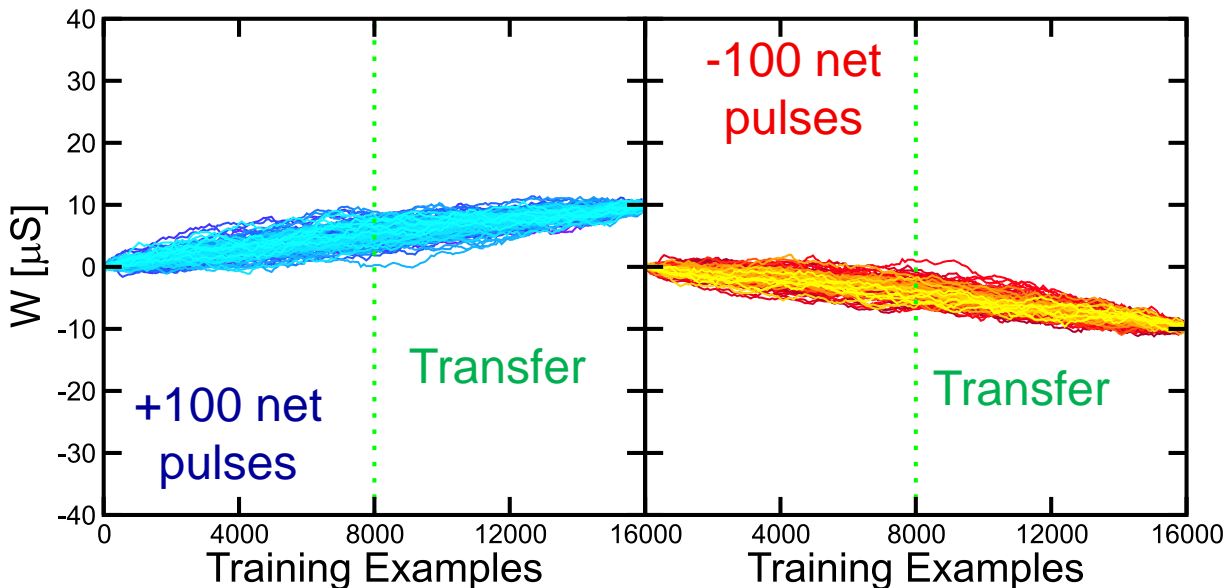
S. Ambrogio et al,
Nature, 558, 60 (2018)

Novel unit cell: 2T2R + 3T1C, nominal behavior



- PMOS charges the capacitor, **increasing** g^+ and W
- NMOS discharges the capacitor, **decreasing** g^+ and W
- Read MOS shows a **linear** dependence of g on V_C
- PMOS and NMOS provide the **same current**, balancing UP and DOWN weight updates

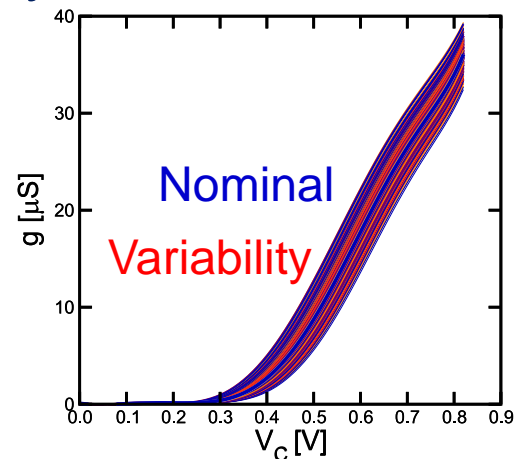
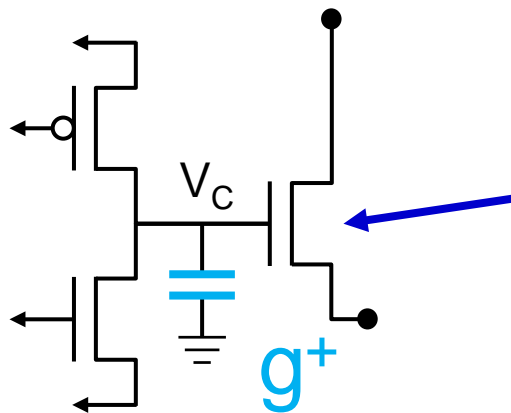
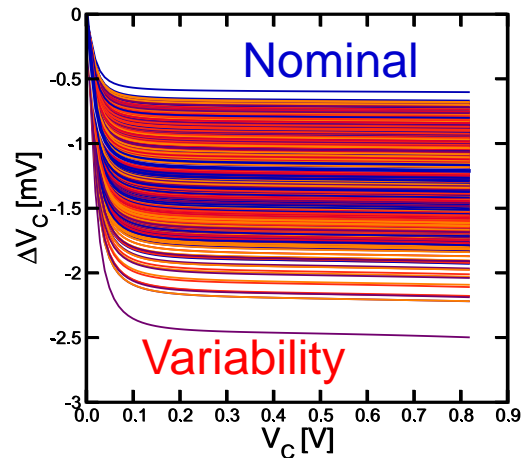
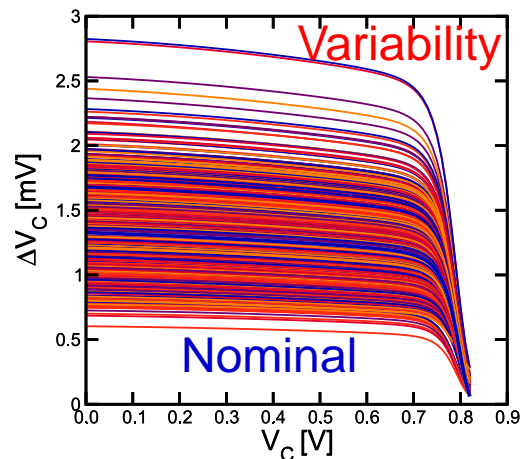
2T2R+3T1C scheme: dependence on applied pulses



- Higher number of requested pulses due to very small g^+ update
- MNIST accuracy is equivalent to accuracy achieved with TensorFlow **on a same size** network

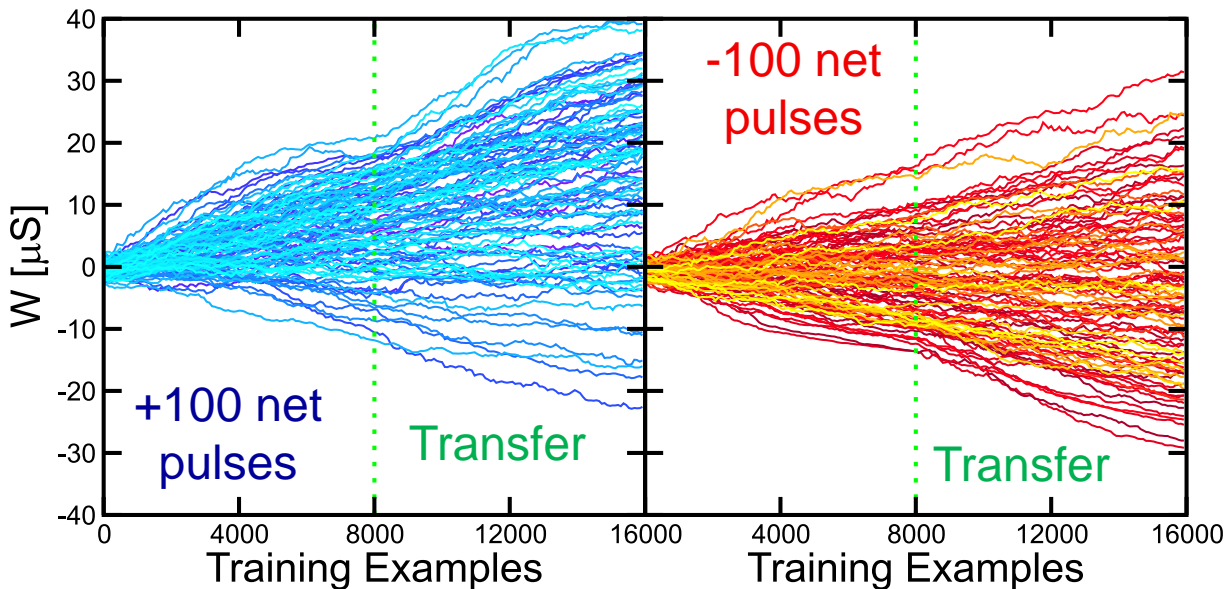
MNIST Accuracy
TensorFlow: 97.94%
2T2R+3T1C: 98.10%

Novel unit cell: 2T2R + 3T1C, CMOS variability

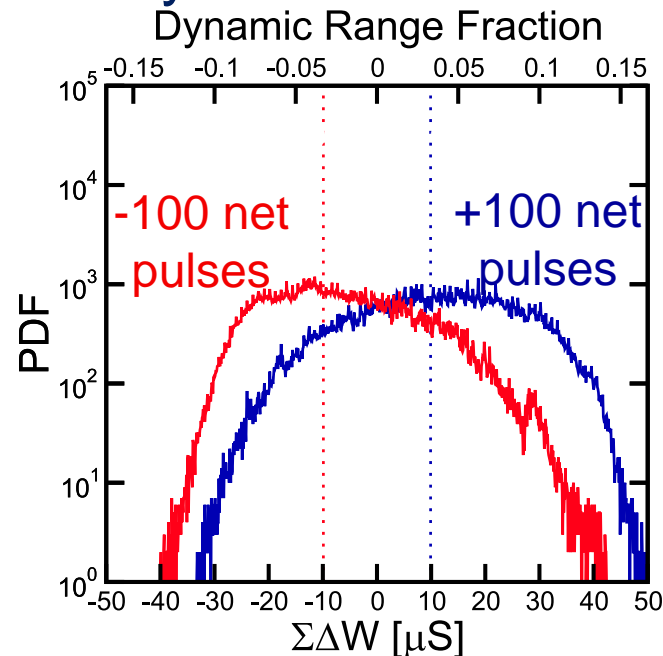


- PMOS charges the capacitor, **increasing** g^+ and W
- NMOS discharges the capacitor, **decreasing** g^+ and W
- Read MOS shows a **linear** dependence of g on V_C
- PMOS and NMOS **never** provide the **same current**, causing **UP and DOWN weight updates asymmetry**

2T2R+3T1C scheme: impact of CMOS variability

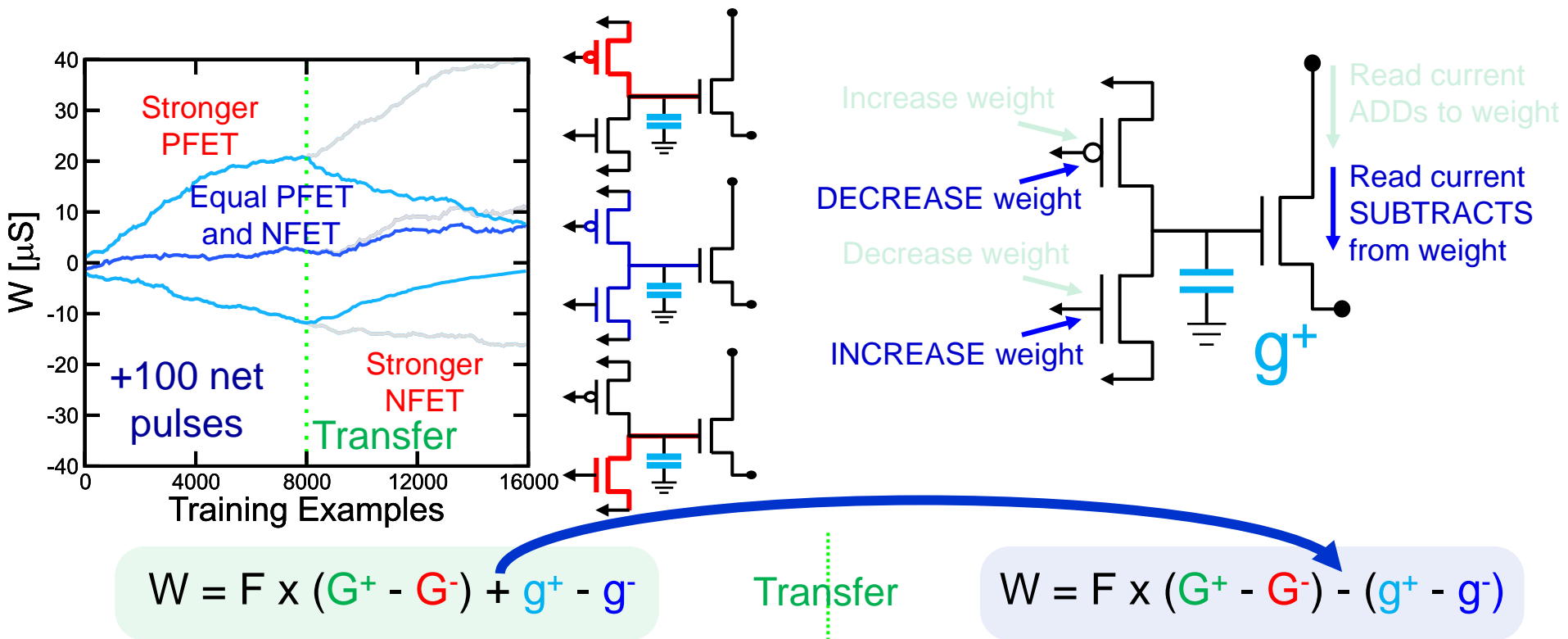


- Asymmetry in PMOS and NMOS strongly broadens $\Sigma\Delta W$ distributions
- MNIST **accuracy is highly degraded** with respect to accuracy achieved with TensorFlow



MNIST Accuracy
TensorFlow: 97.94%
2T2R+3T1C: 98.10%
+Variability: 92.42%

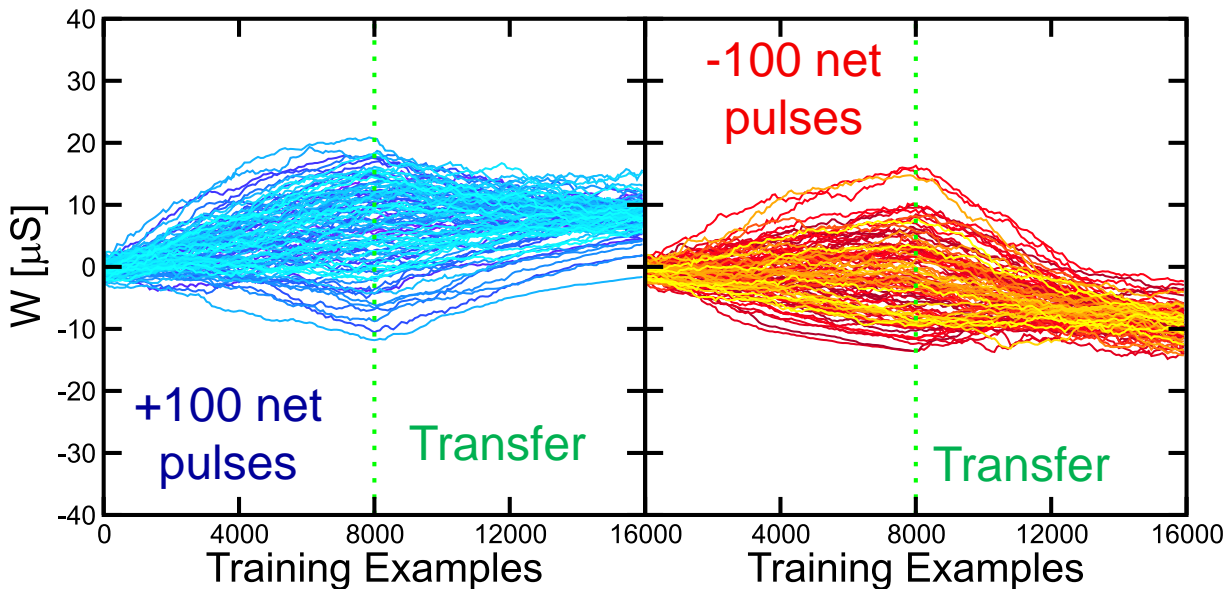
2T2R+3T1C scheme: polarity inversion



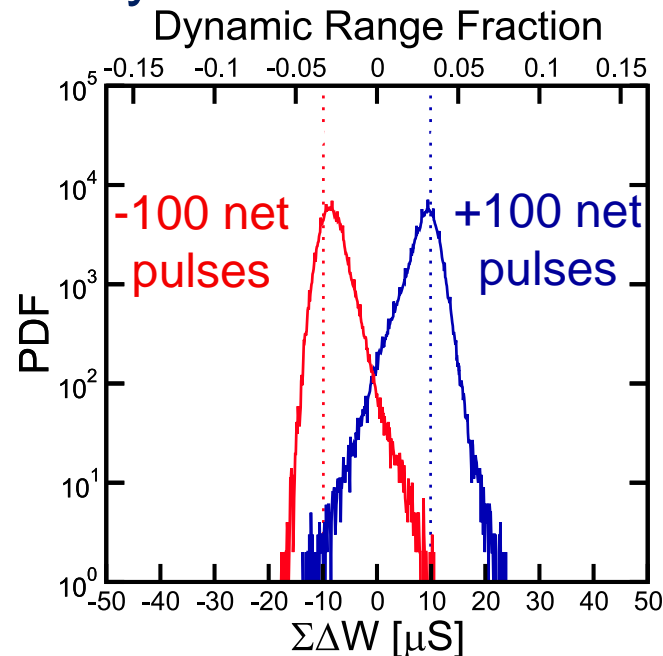
Polarity inversion: Invert the **sign** of the lower significance conductance between transfers to higher significance pair

S. Ambrogio et al, *Nature*, 558, 60 (2018)

2T2R+3T1C scheme: CMOS variability, polarity inversion

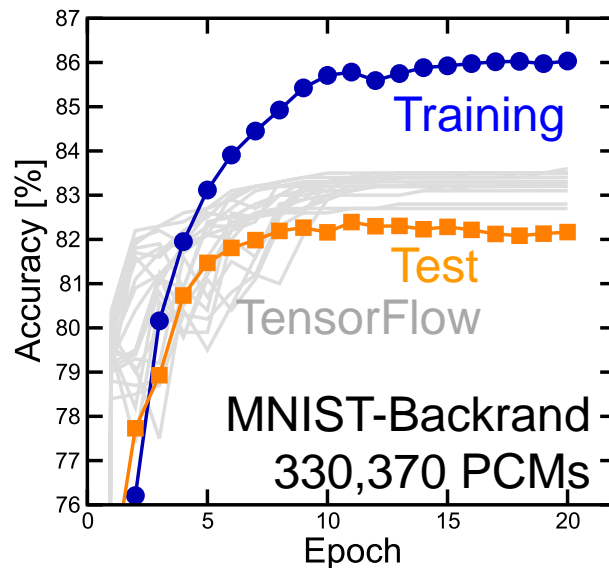
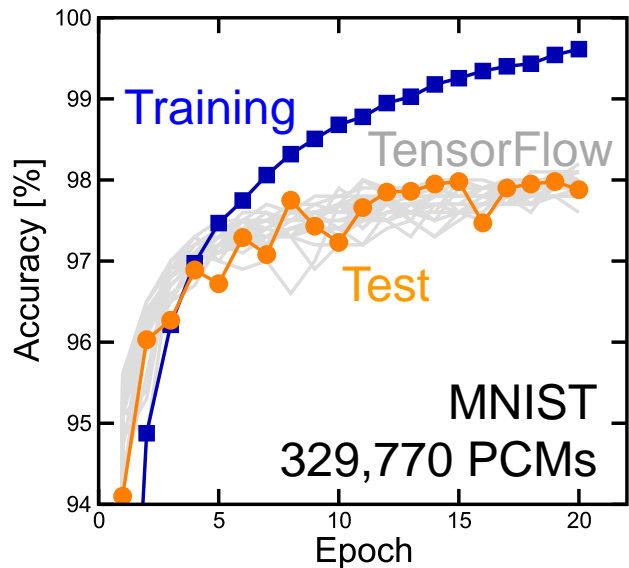


- Asymmetry in PMOS and NMOS is averaged by polarity inversion
- MNIST accuracy is equivalent to accuracy achieved with TensorFlow



MNIST Accuracy
Tensorflow: 97.94%
Polarity Inv: 97.95%

Accuracy on MNIST and MNIST backrand

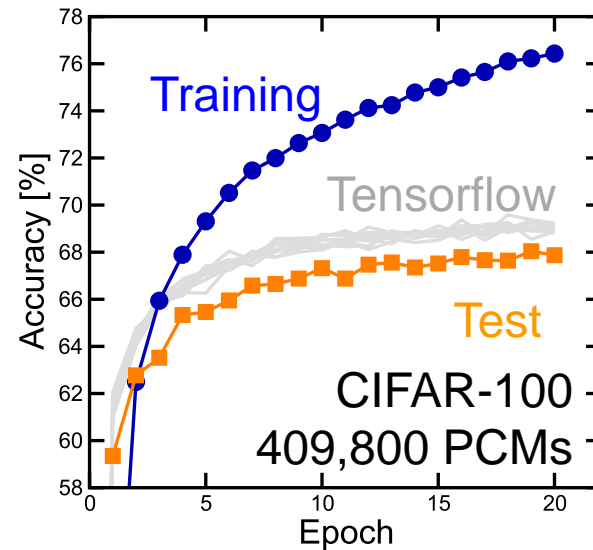
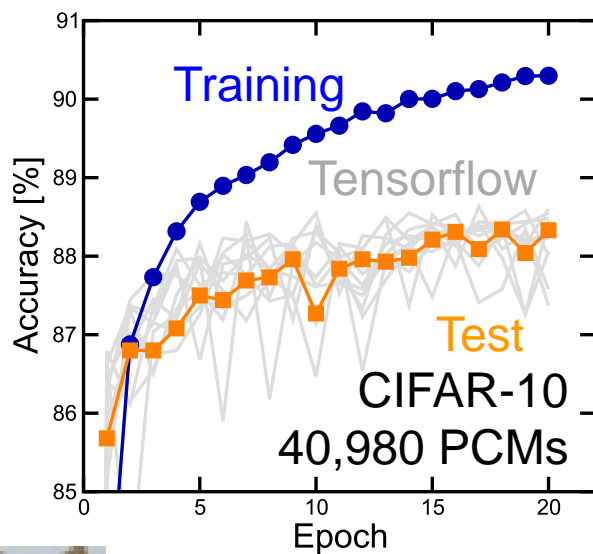


S. Ambrogio et al, *Nature*, 558, 60 (2018)

Mixed hardware-software experiment: every synaptic weight \rightarrow 2 real PCM devices

Transfer learning from ImageNet to CIFAR-10/100

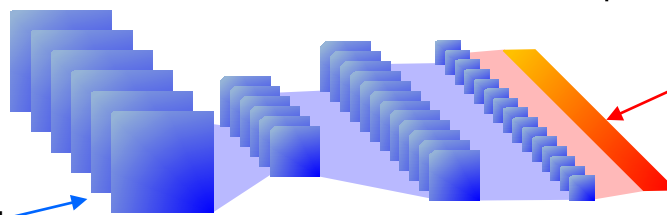
Mixed hardware-software experiment



ImageNET



CIFAR-10/100



Convolutional and Subsampling layers

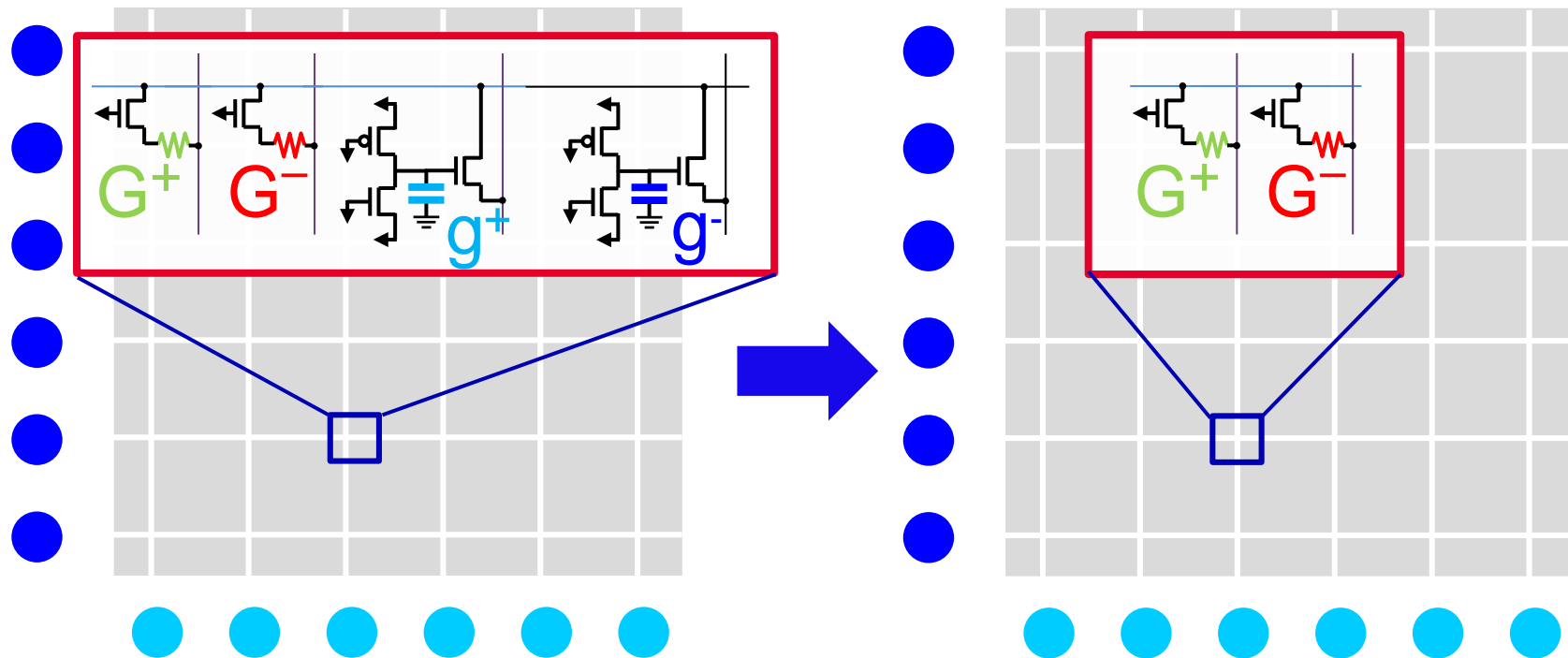
Only train last fully-connected layer

Fully Connected layer

Transfer Learning: Use pre-trained, scaled weights from ImageNET for convolution layers

Full 2-Analog Memory structure

$$W = F \times (G^+ - G^-) + g^+ - g^-$$



- Single pair of devices performing the entire training

Single device requirements

- Several specifications are requested to single resistive device in order to obtain software-equivalent accuracies
- A minimum of 1000 different conductance steps are required → extremely hard to obtain
- A maximum 5% of asymmetry between up and down conductance updates
→ need for very linear and symmetric devices

Our solution → Multiple conductances of varying significance, diversification of requirements

TABLE 2 | Summary of RPU device specifications.

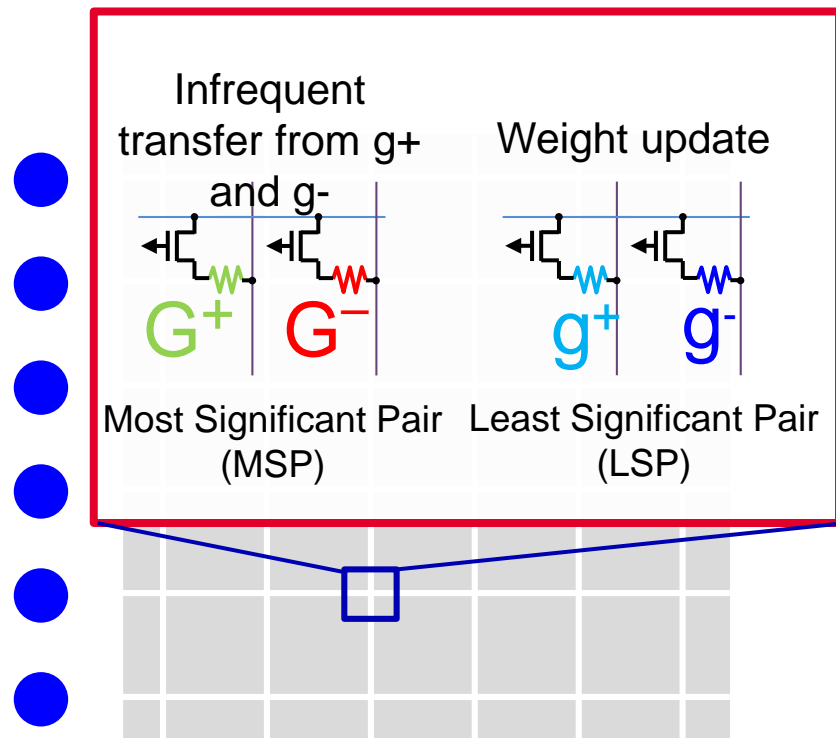
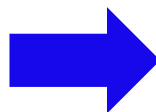
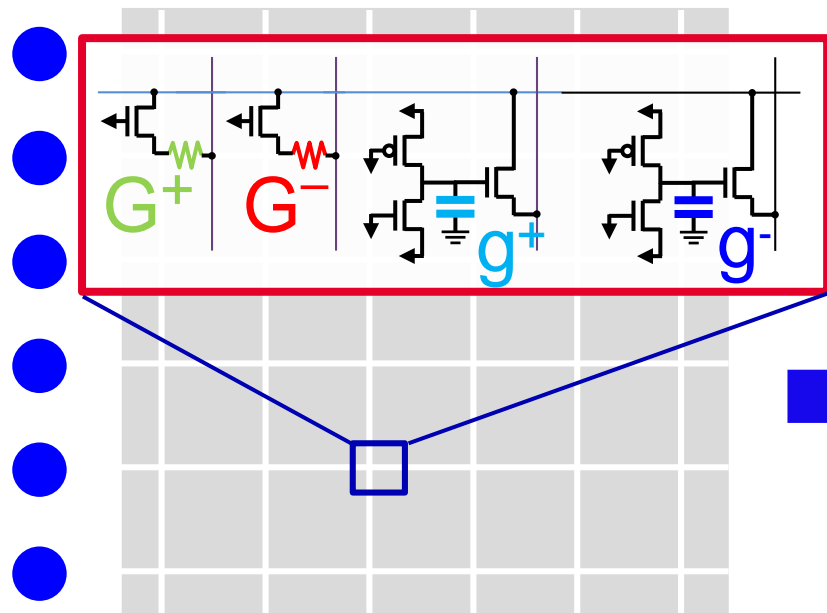
Specs	Parameter	Value	Tolerance
Pulse duration		1 ns	
Operating voltage	$\pm V_S$	1 V	
Maximum device area		0.04 μm^2	
Average device resistance	R_{device}	24 M Ω	7 M Ω
Maximum device resistance	$\max(g_{ij})$	112 M Ω	7 M Ω
Minimum device resistance	$\min(g_{ij})$	14 M Ω	7 M Ω
Resistance on/off ratio	$\max(g_{ij})/\min(g_{ij})$	8	
Resistance change at $\pm V_S$	Δg_{\min}^{\pm}	100 K Ω	30 K Ω
Resistance change at $\pm V_S/2$		10 K Ω	
Storage capacity	$(\max(g_{ij}) - \min(g_{ij}))/\Delta g_{\min}$	1000 levels	
Device up/down asymmetry*	$\Delta g_{\min}^+/\Delta g_{\min}^-$	1.05	2%

Note that these numbers are derived from the radar diagram in **Figure 4A** and correspond to the shaded area. *Global asymmetry in up/down responses can be to a large extent compensated by proper adjustment of pulse widths and/or pulse amplitude.

T. Gokmen, Y. Vlasov, *Frontiers in neuroscience* 10, 333 (2016)

Full 4-Analog Memory structure

$$W = F \times (G^+ - G^-) + g^+ - g^-$$



- **Most Significant Pair:** Infrequent, **Closed Loop Programming** Operation
- **Least Significant Pair:** Frequent, **Open Loop Programming** Operation

Suggestions for new analog memory devices

▪ Larger unit cell with two components

1. More-significant pair of non-volatile conductances (e.g., PCM) stores “most” of the weight info
 - Non-linear conductance update → OK
 - DOES need to be able to tune these conductances rapidly in a CLOSED-LOOP manner
2. We perform all the OPEN-LOOP programming using a “less-significant” pair of conductances
 - Poor retention → OK
 - Significant device-to-device fixed variabilities → OK
 - DOES need to offer highly linear conductance update

→ Reduces the difficulty of device requirements

S. Ambrogio et al, *Nature*, 558, 60 (2018)

G. Cristiano et al, *J. Appl. Phys.* 124 (15), 151901 (2018)

Comparison of device specifications for MSP and LSP

Specifications	Parameter	MSP	LSP
Initial Step-size	$\Delta G_0 (\Delta G_0^*)$	< 21 μS (42%)	< 1.4 μS (2.8%)
Intra-device Variability	σ_{intra}	< 1.5 μS	< 0.8 μS
Inter-device Variability	σ_{Gmax}	< 10 μS	< 12 μS
	$\sigma_{\Delta G_0}^*$	< 200%	< 95%
Faulty devices	Dead C.R.	< 7%	< 7%
	Stuck On C.R.	< 35%	< 10%
Dynamic range	Number of levels	> 13	> 110
Retention	Time before data loss	Higher	Lower
Endurance	Number of Set/Reset	Lower	Higher

Perspective on Training Fully Connected Networks with Resistive Memories: Device Requirements for Multiple Conductances of Varying Significance

Giorgio Cristiano,^{1,2} Massimo Giordano,^{1,2} Stefano Ambrogio,¹ Louis P. Romero,¹ Christina Cheng,¹ Pritish Narayanan,¹ Hsinyu Tsai,¹ Robert M. Shelby,¹ and Geoffrey W. Burr^{1, a)}

¹⁾IBM Research AI, IBM Research-Almaden, 650 Harry Road, San Jose, CA USA 95120

²⁾EPFL, Route Cantonale, 1015 Lausanne, Switzerland

G. Cristiano et al, J. Appl. Phys. 124 (15), 151901 (2018)

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Long-term: maximizing the future business case (vs. a GPU)

Low Power

(inherent in the physics, but possible to lose in the engineering...)

Still of interest for power-constrained situations: learning-in-cars, etc.

Sweet spot: rather than buy GPUs, people buy this chip instead for training of Deep-NN's

Accuracy

(essential that final Deep-NN performance be indistinguishable from GPUs –hardest technical challenge)

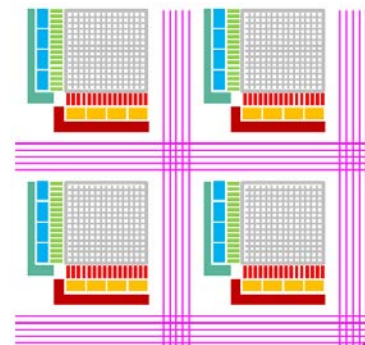
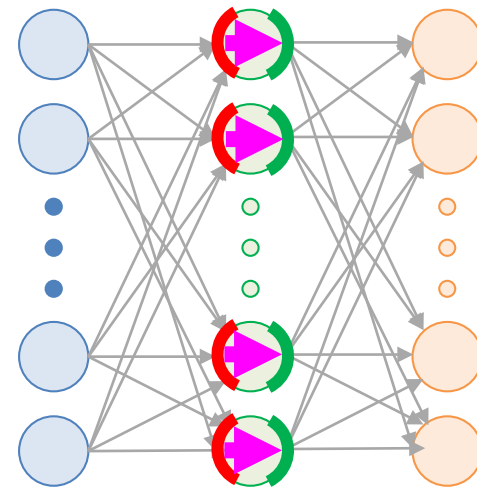
Still of interest for some situations: learning-in-server-room

(circuitry must be massively parallel)

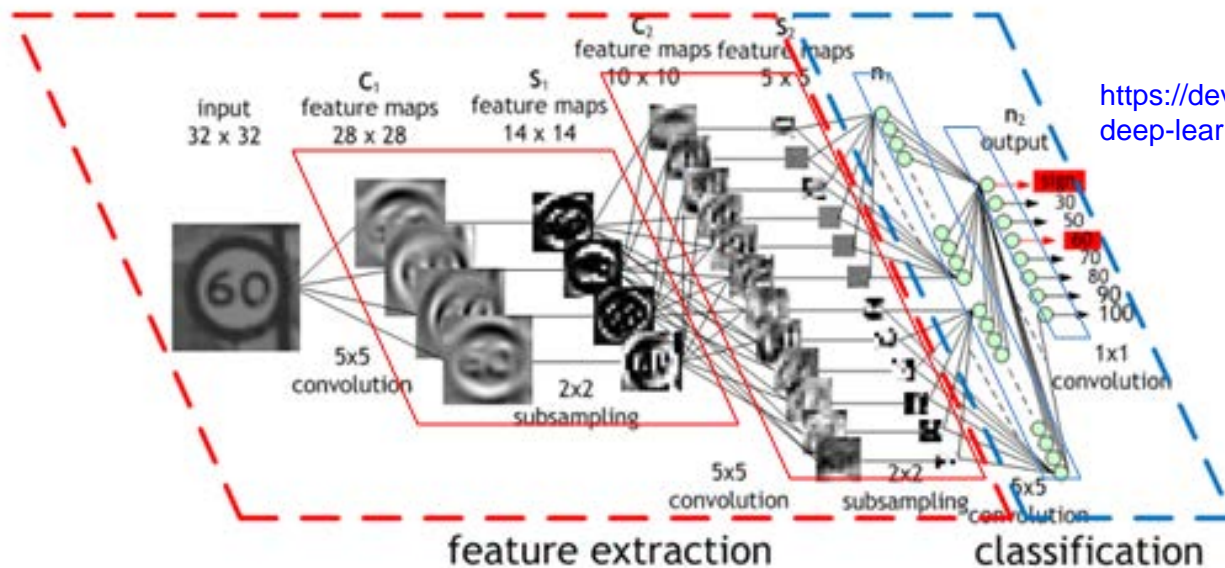
Faster

Suggestions from circuit design work

- 1) Parallelism is key
- 2) Avoiding ADC (Analog-to-Digital Conversion) saves time, power and area
- 3) Do the necessary computations (squashing functions) but be as “approximate” as you can (get away with)
- 4) Need to get vectors of data from the bottom of one array to the edge of the next one
- 5) Digital accelerators are at their best w/ **convolutional** layers; Analog-memory accelerators are at their best w/ **fully-connected** layers.



Impact on Convolutional Neural Networks



<https://devblogs.nvidia.com/parallelforall/deep-learning-nutshell-core-concepts/>

- Only the last layers in a Convolutional Neural Network are Fully Connected due to memory constraints
- Hardware accelerators could easily implement FC layers, what could be the impact on CNN topology and performance?

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Conclusion

- **AI is introducing novel tools to develop solutions to everyday challenges**
 - Brain Inspired approach
 - Deep Learning approach
- **NVM-based crossbar arrays **can accelerate** the training of Deep Machine Learning compared to GPU-based training**
 - Multiply-accumulate performed at the data
 - Possible 500x speedup and orders-of-magnitude lower power
- **Experimental results on a 2T2R+3T1C unit cell demonstrate software-equivalent training accuracy**
 - MNIST, MNIST-backrand, CIFAR-10 and CIFAR-100 tested
- **Need area-efficient peripheral circuitry**
 - Tradeoffs balancing simplicity and area-efficiency against impact on ANN performance

stefano.ambrogio@ibm.com

Photos of us with “our first wafer of PCM-based circuit designs”

Sidney
Tsai

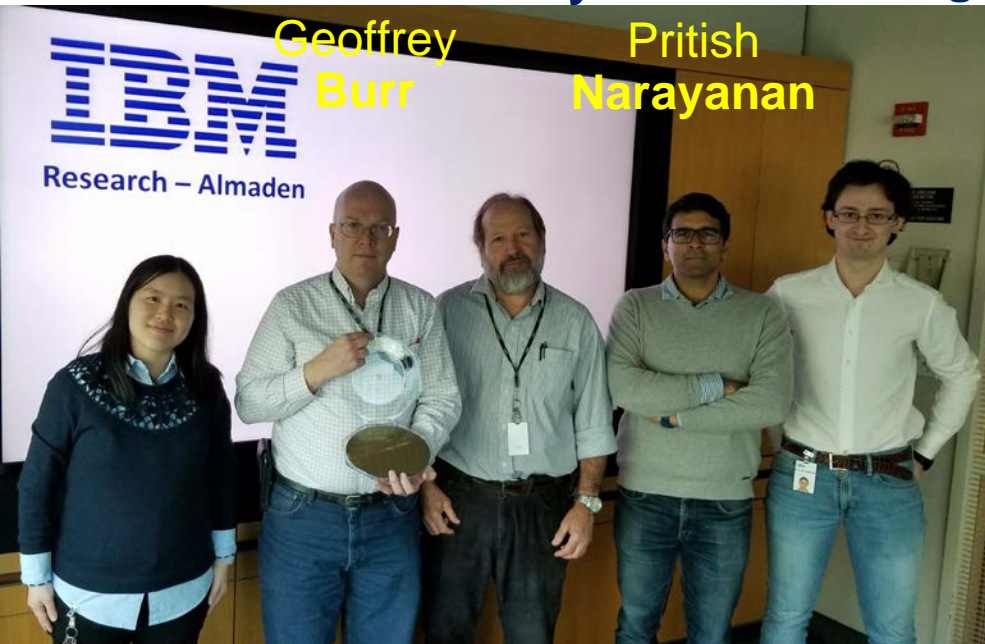
Bob
Shelby

Stefano
Ambrogio

Kohji
Hosokawa

Geoffrey
Burr

Prithish
Narayanan



G. Burr

P. Narayanan



Not shown: Scott C. Lewis (YKT)

Thank you!

stefano.ambrogio@ibm.com

What do we mean by “mixed-hardware-software experiment”?

Full software simulation

Make a few NVM & measure, then capture in a statistical model → **not very accurate!**

NVM devices

Mixed-hardware-software experiment

On-chip memory array
(the real yield, variability, non-ergodic statistics, etc.)

Modeled in software (SPICE) → accurate!

Full hardware experiment

On-chip memory array

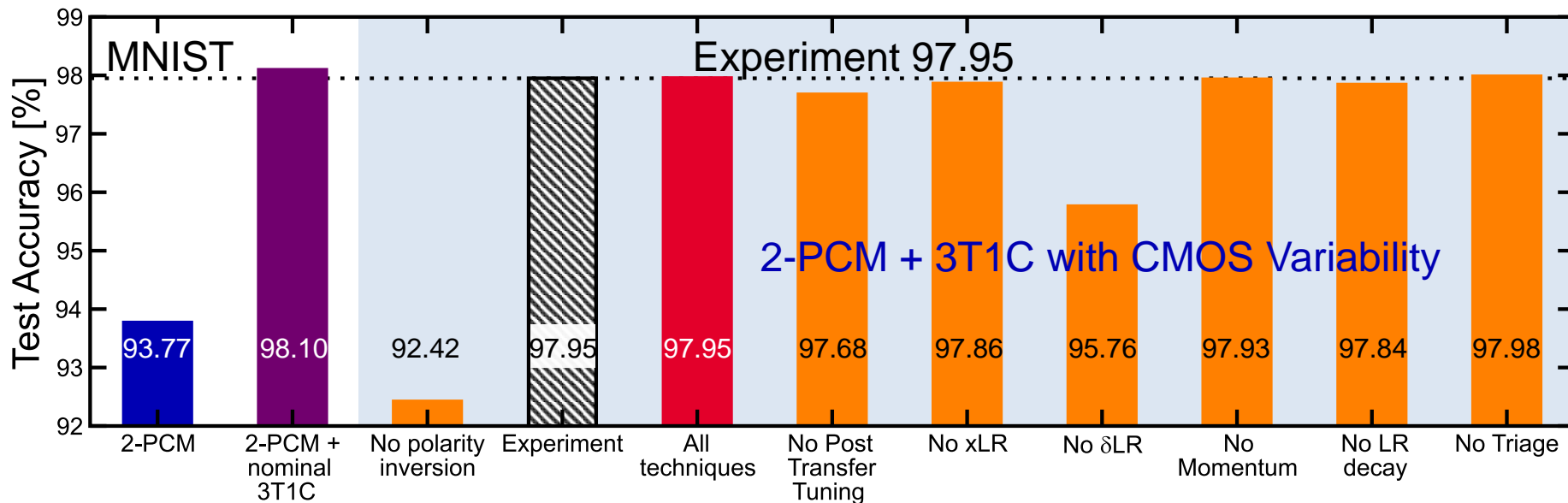
Real CMOS implementation

CMOS

Periphery, Neurons, etc.

Modeled in software (SPICE) → accurate!

Impact of different techniques



- Polarity inversion shows the largest impact on accuracy
- Other techniques show varying importance depending on the training dataset (MNIST, MNIST backrand, CIFAR-10/100)